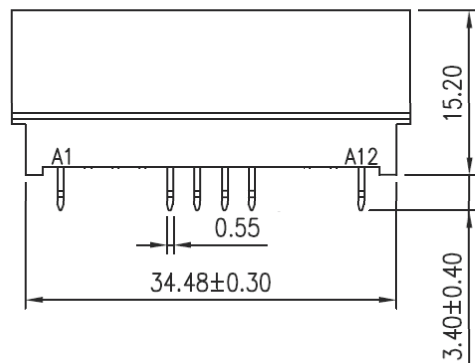
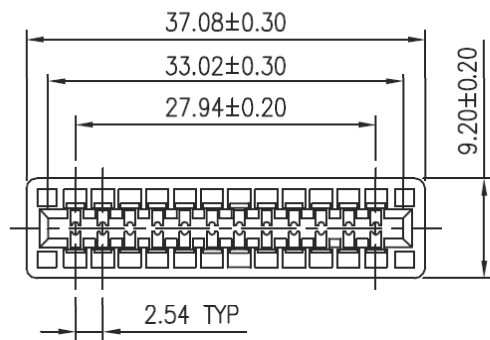


RECOMMENDED PCB LAYOUT

REV	ECN NO.	NAME	DATE
A	920705	Schumi	Jun,26,2003
B	New Release	Milji	

TOLERANCE	
LINEAR	ANGLES
X.±0.40	X°.±
.X±0.30	.X°.±
.XX±0.20	.XX°.±
.XXX±0.10	.XXX°.±

HO CHIEN www.hochien.com		TITLE: CARDEDGE SLOT 24P, 2.54mm PITCH	
		PART NO.	2551-24D-01
APPD: Jason	MAT'L:	DWG NO.	2551-24D-01
CHKD: Schumi	FINISH:		UNITS
DRWN: Milji	Q'TY:		SCALE

UNITS	SCALE	SHEET	REV
MM	1 : 1	1 OF 1	B

MATERIAL
INSULATOR: GLASS-REINFORCED THERMOPLASTIC (PBT),
UL94V-0 RATED.
CONTACT: COPPER ALLOY.
PLATING: MATING AREA-30u" SELECT GOLD OVER NICKEL.
SOLDER AREA- TIN OVER NICKEL.

ELECTRICAL
DIELECTRIC WITHSTANDING VOLTAGE: 1,000 VAC RMS.
CURRENT RATING: 3 AMP.
INSULATION RESISTANCE: 5,000 MEG. OHMS MIN. AT 500 VDC.
CONTACT RESISTANCE: 20 MILLI OHMS MAX.

MECHANICAL
INSERTION FORCE: 340 GRAMS MAX PER CONTACT PAIR.
WITHDRAWAL FORCE: 28 GRAMS MIN PER CONTACT PAIR.

ENVIRONMENTAL
TEMPERATURE RANGE: -55° TO +85°.

PART NO. 2551-24D-01
PIN# 1 2 9 10 11 12 13 14 15 16 23 24
LOAD

